TOSHIBA Transistor Silicon NPN Epitaxial Planar Type (PCT process)

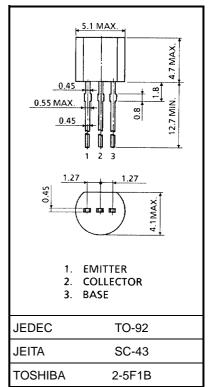
# 2SC1923

High Frequency Amplifier Applications FM, RF, MIX, IF Amplifier Applications

- Small reverse transfer capacitance:  $C_{re}$  = 0.7 pF (typ.)
- Low noise figure: NF = 2.5dB (typ.) (f = 100 MHz)

### Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Collector-base voltage	V <sub>CBO</sub>	40	V
Collector-emitter voltage	V <sub>CEO</sub>	30	V
Emitter-base voltage	V <sub>EBO</sub>	4	V
Collector current	Ι <sub>C</sub>	20	mA
Base current	Ι <sub>Β</sub>	4	mA
Collector power dissipation	PC	100	mW
Junction temperature	Tj	125	°C
Storage temperature range	T <sub>stg</sub>	-55~125	°C



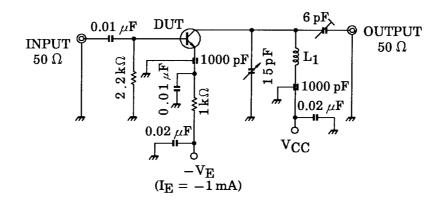
Weight: 0.21 g (typ.)

### **Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	$V_{CB} = 18 V, I_{E} = 0$		_	0.5	μA
Emitter cut-off current	I <sub>EBO</sub>	$V_{EB} = 4 V$ , $I_C = 0$	_	_	0.5	μA
DC current gain	h <sub>FE</sub> (Note)	$V_{CE} = 6 \text{ V}, \text{ I}_{C} = 1 \text{ mA}$	40		200	
Reverse transfer capacitance	C <sub>re</sub>	V <sub>CE</sub> = 6 V, f = 1 MHz	_	0.70	_	pF
Transition frequency	f <sub>T</sub>	$V_{CE} = 6 V, I_{C} = 1 mA$	_	550	_	MHz
Collector-base time constant	C <sub>c</sub> .r <sub>bb'</sub>	$V_{CE} = 6 \text{ V}, \text{ I}_{E} = -1 \text{ mA}, \text{ f} = 30 \text{ MHz}$	_	_	30	ps
Noise figure	NF	V <sub>CE</sub> = 6 V, I <sub>E</sub> = -1 mA, f = 100 MHz,		2.5	4.0*	dB
Power gain	G <sub>pe</sub>	Figure 1	15	18	_	dB

Note: hFE classification R: 40~80, O: 70~140, Y: 100~200 (\* NF = 5.0dB max)

Unit: mm



L1: 0.8 mm | silver plated copper wire, 4 T, 10ID, 8 LENGTH



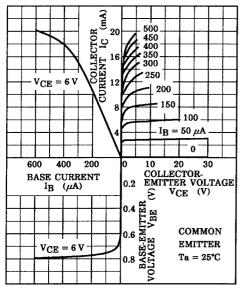
#### y Parameter (typ.)

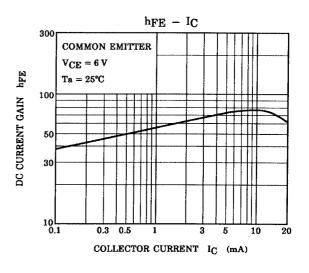
(1) Common emitter (V <sub>CE</sub> = 6 V, I <sub>E</sub> = $-1$ mA, f = 100 MHz)				
Characteristics	Symbol	Тур.	Unit	
Input conductance	gie	2.9	mS	
Input capacitance	C <sub>ie</sub>	10.2	pF	
Reverse transfer admittance	y <sub>re</sub>	0.33	μS	
Phase angle of reverse transfer admittance	$\theta_{\text{re}}$	-90	o	
Forward transfer admittance	y <sub>fe</sub>	40	mS	
Phase angle of forward transfer admittance	$\theta_{\text{fe}}$	-20	o	
Output conductance	goe	45	μS	
Output capacitance	C <sub>oe</sub>	1.1	pF	

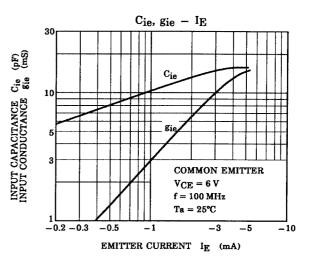
(2) Common base ( $V_{CE} = 6 V$ ,  $I_E = -1 mA$ , f = 100 MHz)

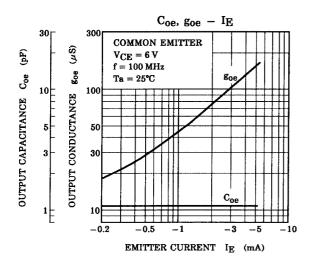
Characteristics	Symbol	Тур.	Unit
Input conductance	gib	34	mS
Input capacitance	C <sub>ib</sub>	-10	pF
Reverse transfer admittance	y <sub>rb</sub>	0.27	μS
Phase angle of reverse transfer admittance	$\theta_{\text{rb}}$	-105	o
Forward transfer admittance	y <sub>fb</sub>	34	mS
Phase angle of forward transfer admittance	$\theta_{\text{fb}}$	165	o
Output conductance	9 <sub>ob</sub>	45	μS
Output capacitance	C <sub>ob</sub>	1.1	pF

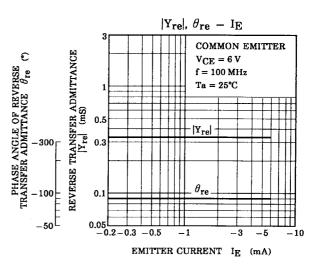
STATIC CHARACTERISTICS



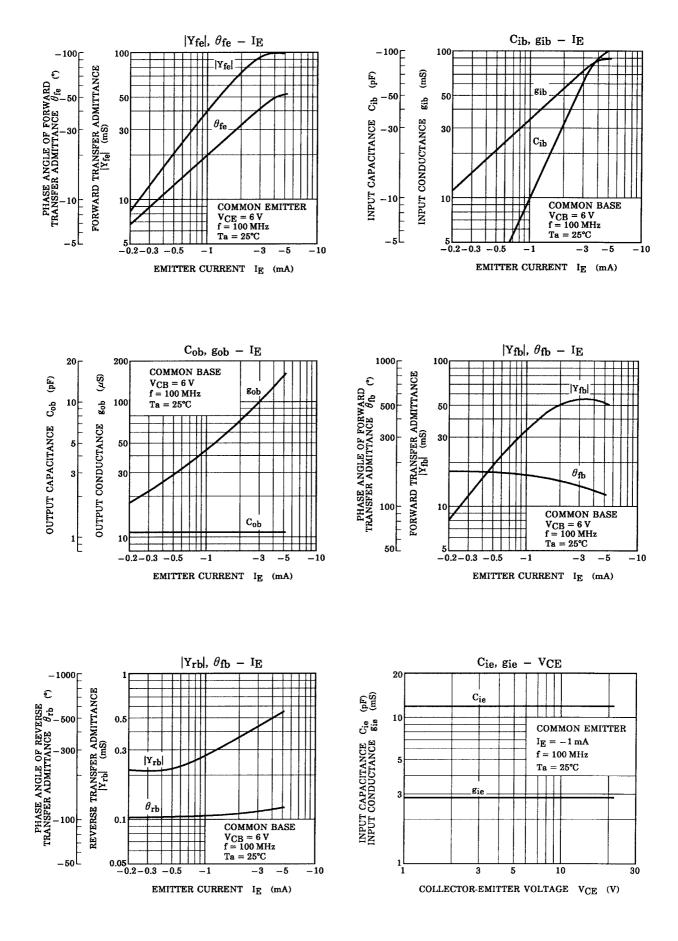




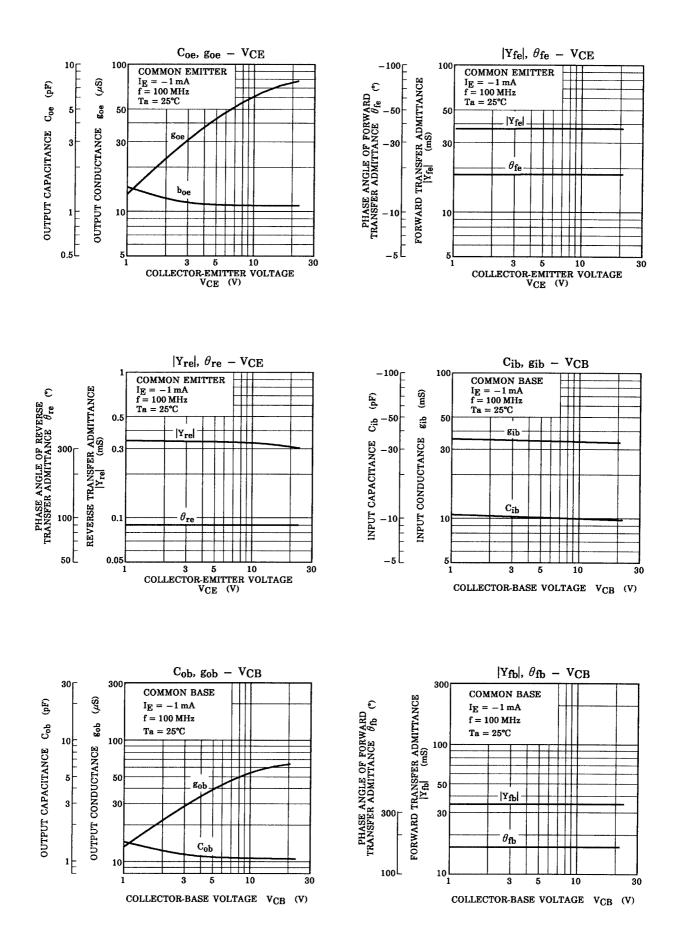




### **TOSHIBA**



## TOSHIBA



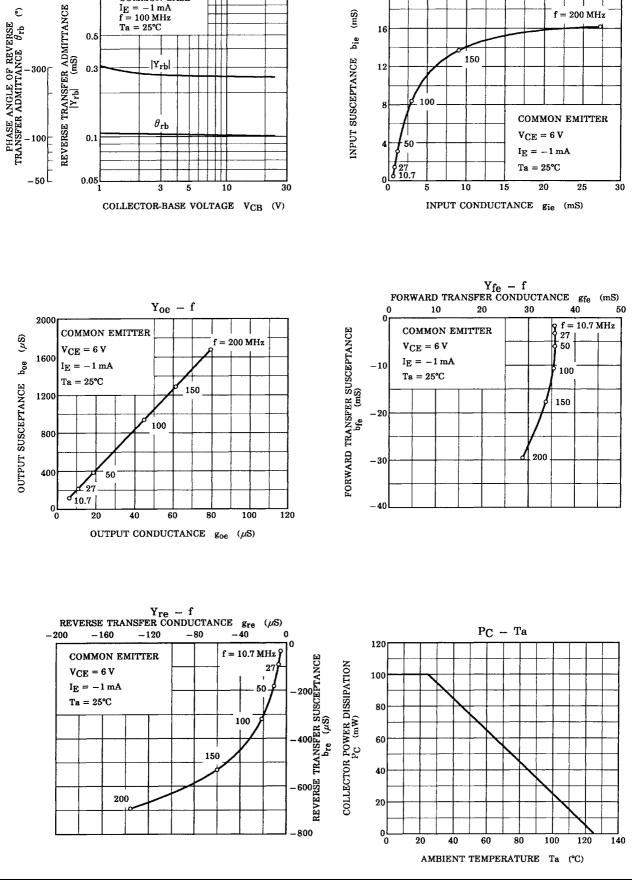
### **TOSHIBA**

 $|Y_{rb}|, \theta_{rb} - VCB$ 

COMMON BASE

 $Y_{ie} - f$ 

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